

131,072-WORD BY 8-BIT CMOS STATIC RAM

DESCRIPTION

The TC558128AJ is a 1,048,576-bit high-speed static random access memory (SRAM) organized as 131,072 words by 8 bits. Fabricated using CMOS technology and advanced circuit techniques to provide high speed, it operates from a single 5 V power supply. There are two control inputs. Chip enable ($\overline{CE}$) can be used to place the device in a low-power mode, and output enable ($\overline{OE}$) provides fast memory access. This device is well suited to cache memory applications where high-speed access and high-speed storage are required. All inputs and outputs are directly TTL compatible. The TC558128AJ is available in a plastic 32-pin SOJ package (400 mil width) for high density surface assembly.

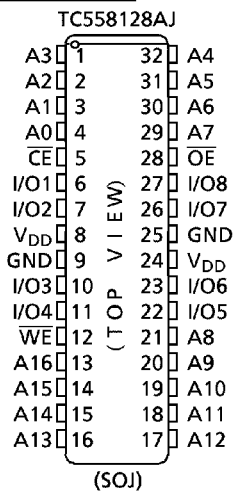
FEATURES

- Fast access time (the following are maximum values)
 - TC558128AJ-15: 15 ns
 - TC558128AJ-20: 20 ns
- Low-power dissipation (the following are maximum values)
- Single power supply voltage of $5\text{ V} \pm 10\%$.
- Fully static operation
- All inputs and outputs are TTL compatible
- Output buffer control using $\overline{OE}$
- Package:
 - SOJ32-P-400-1.27A (Weight: 1.22 g typ)

Cycle Time	15	20	25	30	50	ns
Operation (max)	170	140	130	120	100	mA

Standby: 1 mA (both devices)

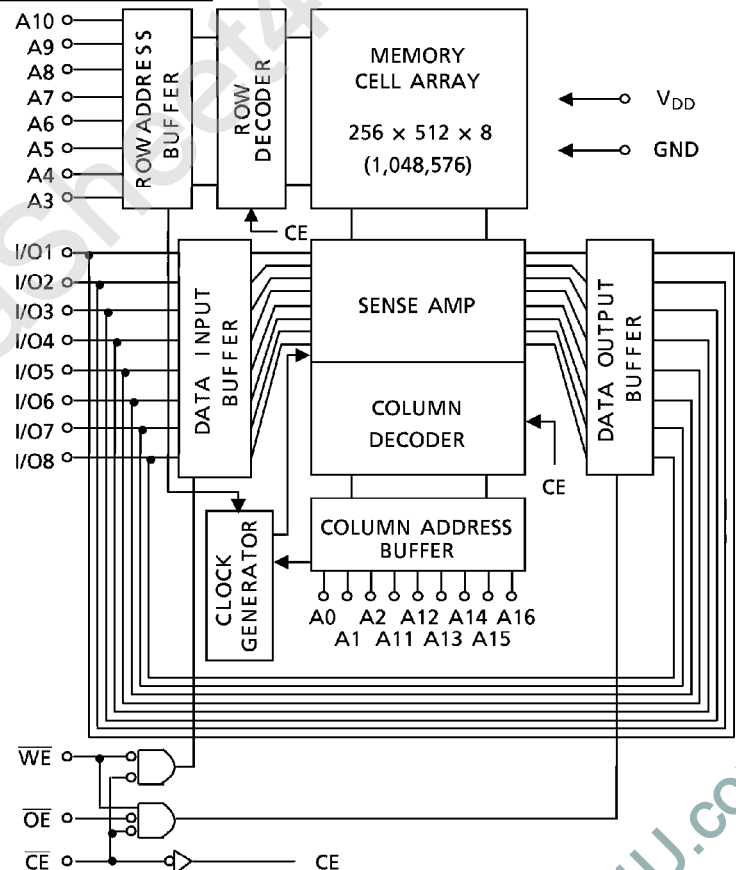
PIN ASSIGNMENT



PIN NAMES

A0 to A16	Address Inputs
I/O1 to I/O8	Data Inputs/Outputs
$\overline{CE}$	Chip Enable
$\overline{WE}$	Write Enable Input
$\overline{OE}$	Output Enable
V_{DD}	Power (+ 5 V)
GND	Ground

BLOCK DIAGRAM



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MAXIMUM RATINGS

SYMBOL	RATING	VALUE	UNIT
V_{DD}	Power Supply Voltage	- 0.5 to 7.0	V
V_{IN}	Input Terminal Voltage	- 2.0 * to 7.0	V
$V_{I/O}$	Input/Output Terminal Voltage	- 0.5 * to $V_{DD} + 0.5$	V
P_D	Power Dissipation	1.1	W
T_{solder}	Soldering Temperature (10 s)	260	°C
T_{strg}	Storage Temperature	- 65 to 150	°C
T_{opr}	Operating Temperature	- 10 to 85	°C

*: - 3 V with a pulse width of 10 ns

DC RECOMMENDED OPERATING CONDITIONS ($T_a = 0^\circ$ to 70°C)

SYMBOL	PARAMETER	MIN	TYP	MAX	UNIT
V_{DD}	Power Supply Voltage	4.5	5.0	5.5	V
V_{IH}	Input High Voltage	2.2	-	$V_{DD} + 0.5$	V
V_{IL}	Input Low Voltage	- 0.5 *	-	0.8	V

*: - 3 V with a pulse width of 10 ns

DC CHARACTERISTICS ($T_a = 0^\circ$ to 70°C , $V_{DD} = 5\text{ V} \pm 10\%$)

SYMBOL	PARAMETER	TEST CONDITION		MIN	TYP	MAX	UNIT
I _{IL}	Input Leakage Current	V _{IN} = 0 V to V _{DD}		–	–	± 10	μA
I _{LO}	Output Leakage Current	CE = V _{IH} or WE = V _{IL} or OE = V _{IH} V _{OUT} = 0 V to V _{DD}		–	–	± 10	μA
I _{OH}	Output High Current	V _{OH} = 2.4 V		– 4	–	–	mA
I _{OL}	Output Low Current	V _{OL} = 0.4 V		8	–	–	mA
I _{DDO}	Operating Current	CE = V _{IL} , I _{out} = 0 mA Other Inputs = V _{IH} or V _{IL}	tcycle = 15 ns	–	–	170	mA
			tcycle = 20 ns	–	–	140	
			tcycle = 25 ns	–	–	130	
			tcycle = 30 ns	–	–	120	
			tcycle = 50 ns	–	–	100	
I _{DDS1}	Standby Current	CE = V _{IH} , Other Inputs = V _{IH} or V _{IL}		–	–	30	mA
I _{DDS2}		CE = V _{DD} – 0.2 V Other Inputs = V _{DD} – 0.2 V or 0.2 V		–	–	1	

CAPACITANCE ($T_a = 25^\circ\text{C}$, $f = 1.0\text{ MHz}$)

SYMBOL	PARAMETER	TEST CONDITION	MAX	UNIT
C_{IN}	Input Capacitance	$V_{IN} = \text{GND}$	6	pF
$C_{I/O}$	Input/Output Capacitance	$V_{I/O} = \text{GND}$	8	pF

Note: This parameter is periodically sampled and is not 100% tested.

OPERATING MODE

MODE	$\overline{\text{CE}}$	$\overline{\text{OE}}$	$\overline{\text{WE}}$	I/O1 to I/O8	POWER
Read	L	L	H	Output	I_{DDO}
Write	L	x	L	Input	I_{DDO}
Outputs Disable	L	H	H	High Impedance	I_{DDO}
Standby	H	x	x	High Impedance	I_{DDs}

x: Don't care

AC CHARACTERISTICS (Ta = 0° to 70°C (Note 1), VDD = 5 V ± 10%)

READ CYCLE

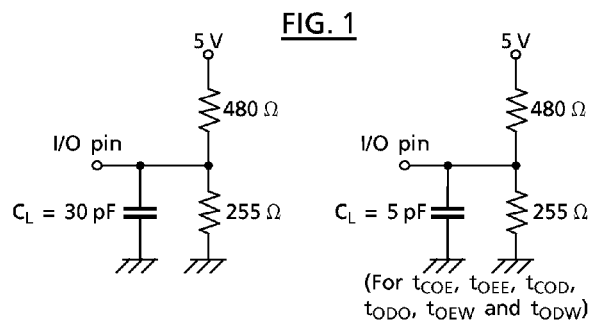
SYMBOL	PARAMETER	TC558128AJ-15		TC558128AJ-20		UNIT
		MIN	MAX	MIN	MAX	
t _{RC}	Read Cycle Time	15	–	20	–	ns
t _{ACC}	Address Access Time	–	15	–	20	
t _{CO}	Chip Enable Access Time	–	15	–	20	
t _{OE}	Output Enable Access Time	–	8	–	10	
t _{OH}	Output Data Hold Time from Address Change	5	–	5	–	
t _{COE}	Output Enable Time from Chip Enable	5	–	5	–	
t _{OEE}	Output Enable Time from Output Enable	1	–	1	–	
t _{COD}	Output Disable Time from Chip Enable	–	8	–	8	
t _{ODO}	Output Disable Time from Output Enable	–	8	–	8	

WRITE CYCLE

SYMBOL	PARAMETER	TC558128AJ-15		TC558128AJ-20		UNIT
		MIN	MAX	MIN	MAX	
t _{WC}	Write Cycle Time	15	–	20	–	ns
t _{WP}	Write Pulse Width	9	–	10	–	
t _{CW}	Chip Enable to End of Write	12	–	13	–	
t _{AW}	Address Valid to End of Write	12	–	13	–	
t _{AS}	Address Setup Time	0	–	0	–	
t _{WR}	Write Recovery Time	0	–	0	–	
t _{DS}	Data Setup Time	8	–	10	–	
t _{DH}	Data Hold Time	0	–	0	–	
t _{OE_W}	Output Enable Time from Write Enable	1	–	1	–	
t _{OD_W}	Output Disable Time from Write Enable	–	8	–	8	

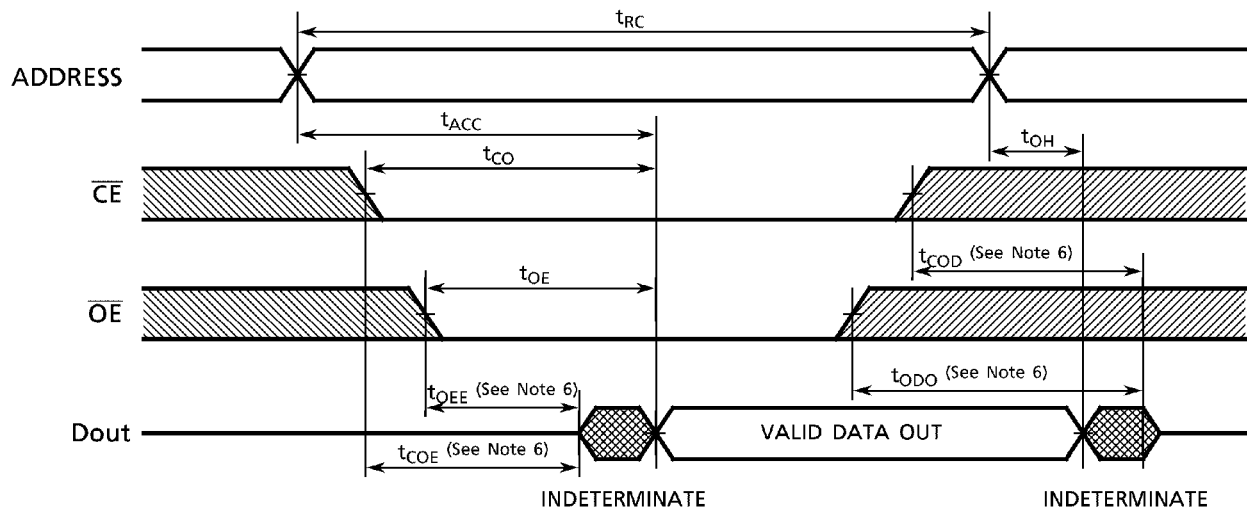
AC TEST CONDITIONS

Input Pulse Level	3.0 V, 0.0 V
Input Pulse Rise and Fall Time	3 ns
Input timing Measurement Reference Level	1.5 V
Output Timing Measurement Reference Level	1.5 V
Output Load	Fig. 1

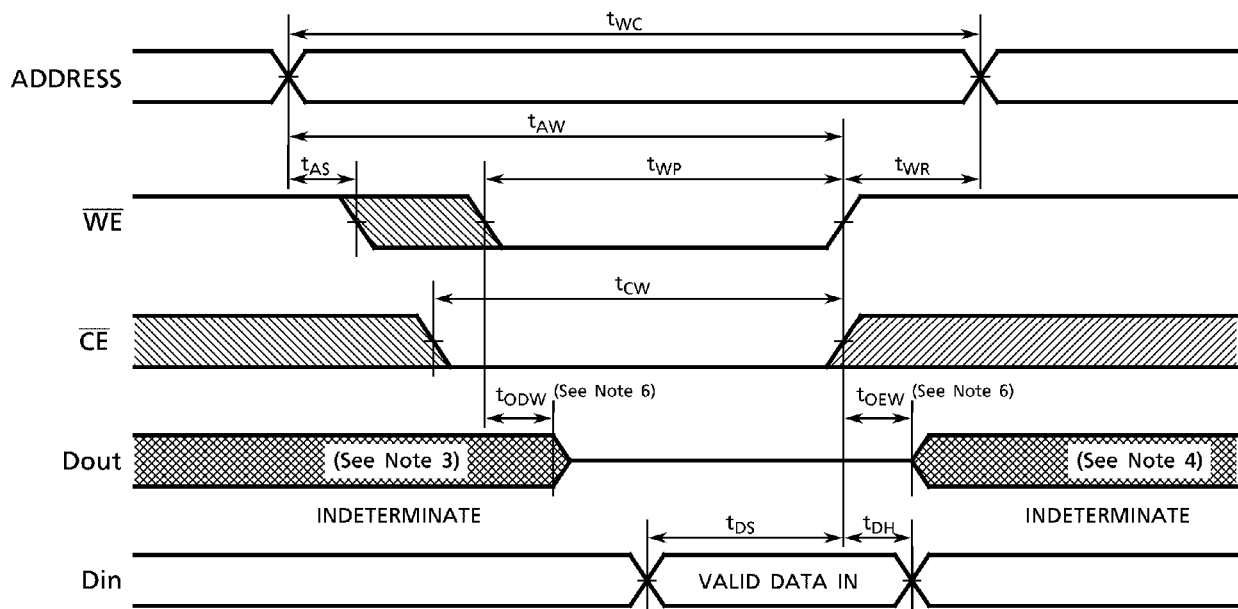


TIMING DIAGRAMS

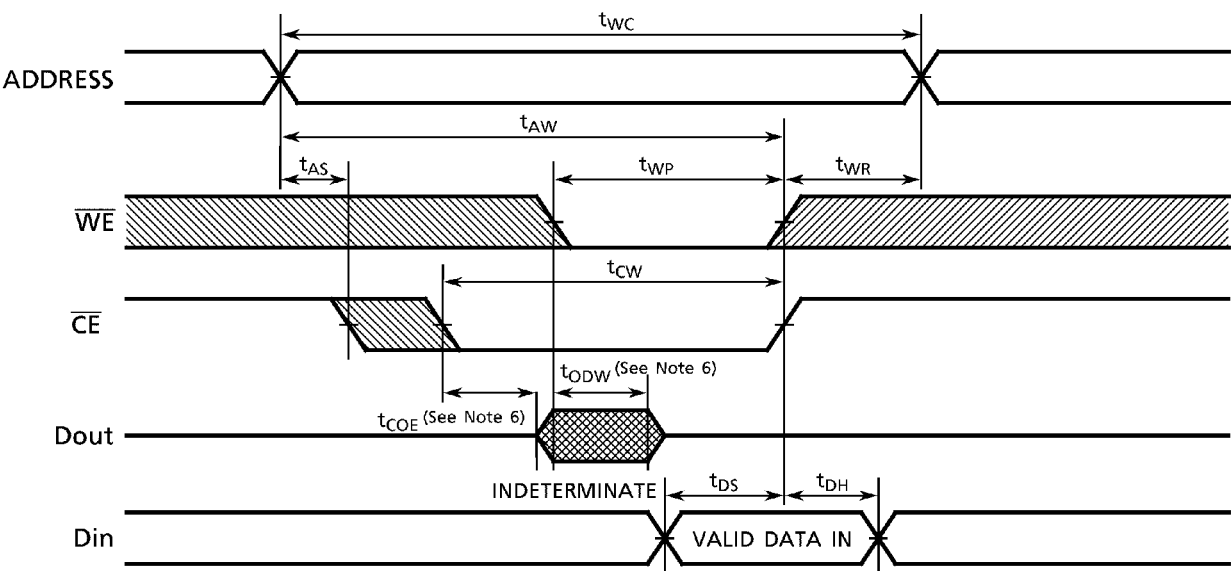
READ CYCLE (See Note 2)



WRITE CYCLE 1 ($\overline{WE}$ CONTROLLED) (See Note 5)



WRITE CYCLE 2 ($\overline{\text{CE}}$ CONTROLLED) (See Note 5)



Note: (1) Operating temperature (T_a) is guaranteed for transverse air flow exceeding 400 linear feet per minute.

(2) $\overline{WE}$ remains HIGH for the Read Cycle.

(3) If $\overline{CE}$ goes LOW coincident with or after $\overline{WE}$ goes LOW, the outputs will remain at high impedance.

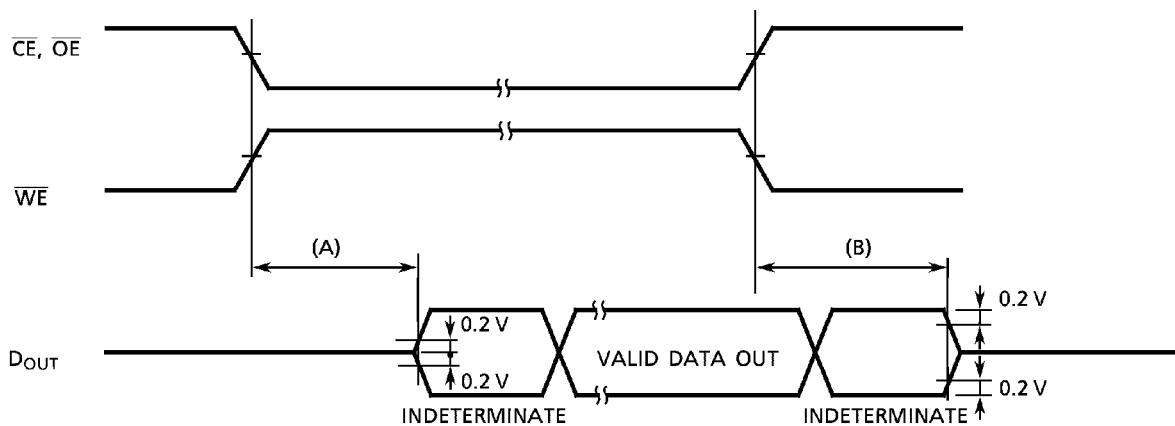
(4) If $\overline{CE}$ goes HIGH coincident with or before $\overline{WE}$ goes HIGH, the outputs will remain at high impedance.

(5) If $\overline{OE}$ is HIGH during the write cycle, the outputs will remain at high impedance.

(6) The parameters specified below are measured using the load shown in Fig. 1.

(A) $t_{COE}, t_{OEE}, t_{OE\overline{W}}$ Output Enable Time

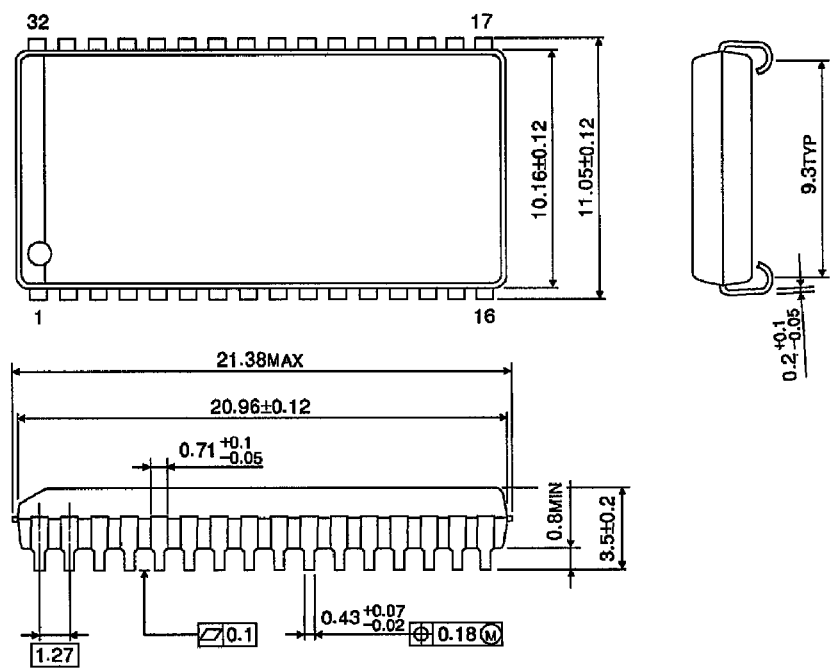
(B) $t_{COD}, t_{ODO}, t_{OD\overline{W}}$ Output Disable Time



PACKAGE DIMENSIONS

Plastic SOJ (SOJ32-P-400-1.27A)

Units in mm



Weight: 1.22 g (typ)